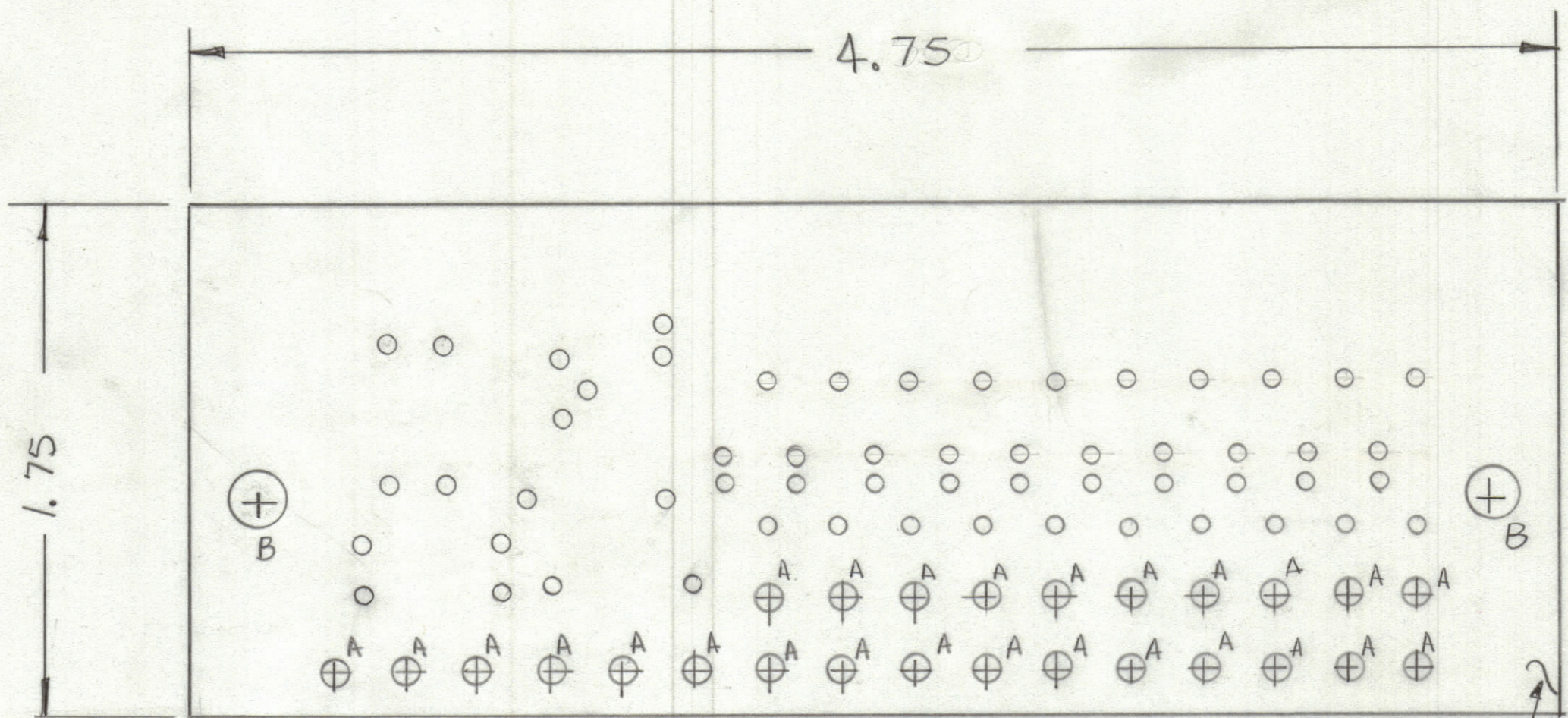


REVISIONS							
ZONE	LTR	DESCRIPTION	DATE	E.M.N.NO	DRAFT	CHKD	APPD
	Q	ORIGINAL RELEASE	2/16/83				



FABRICATION NOTES:
 TO BE MANUFACTURED IN ACCORDANCE WITH TMC SPEC S735 AND SPECIFICALLY
 1. OVERALL MATERIAL THICKNESS .062[±].006 AS PER (pp3.1,3.2)
 2. CONDUCTOR PATTERN TO BE COPPER FOIL AS PER (pp4.1), PLATING TO BE TIN LEAD AS PER (pp13.2.2,13.2.1)
 3. MATERIAL TO BE G10 GLASS EPOXY, LAMINATE 2 OZ COPPER CLAD, (SINGLE SIDE)

Hole	Description	Req
A	.081 DIA	26
B	11/64 DIA	2
	UNMARKED HOLES .042 DIA	57

1	AX806 HFTR-1K/12B(SUBIMMUNE)	A5800
QTY / UNIT	MODEL USED ON	ASS'Y NO.
APPLICATION		
	CODE	
NOTICE TO PERSONS RECEIVING THIS DRAWING		
THE TECHNICAL MATERIEL CORPORATION claims proprietary right in the material disclosed hereon. This drawing is issued in confidence for engineering information only and may not be reproduced or used to manufacture anything shown hereon without permission from THE TECHNICAL MATERIEL CORPORATION to the user. This drawing is loaned for mutual assistance and is subject to recall at any time.		

SCALE 2:1

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES	
TOLERANCES ON	
DECIMALS	FRACTIONS
.X ± .05	± 1/64
.XX ± .01	ANGLES
.XXX ± .005	± 0° -30'
MATERIAL	
FINISH	

26	1	TE127-2	TERMINAL STUD	A
QTY. REQ.	ITEM	PART NO.	DESCRIPTION	SYMBOL
LIST OF MATERIAL				
FINAL APPROVAL		DATE		THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK PRINTED Circuit Bd GATING CIRCUIT
MECH. DES.		DATE		
ELECT. DES.		DATE		
CHECKED		DATE		
DRAWN		DATE		
		6-8-82		
SIZE	CODE IDENT.NO	DWG NO.		ISSUE
C	82679	PC831		Q
SCALE			SHEET	OF